

关。GDAŃSK UNIVERSITY 创 OF TECHNOLOGY

Subject card

Subject name and code	, PG_00039700							
Field of study	Materials Engineering, Materials Engineering							
Date of commencement of studies	February 2024		Academic year of realisation of subject			2024/2025		
Education level	second-cycle studies		Subject group			Optional subject group Subject group related to scientific research in the field of study		
Mode of study	Full-time studies		Mode of delivery			at the university		
Year of study	1		Language of instruction			Polish		
Semester of study	2		ECTS credits			3.0		
Learning profile	general academic profile		Assessment form			assessment		
Conducting unit	Department of Metrology and Optoelectronics -> Faculty of Electronics, Telecommunications and Ir					nd Informatics		
Name and surname	Subject supervisor dr hab. inż. Robert Bogdanowicz							
of lecturer (lecturers)	Teachers							
Lesson types and methods of instruction	Lesson type	Lecture	Tutorial	Laboratory	Projec	:t	Seminar	SUM
	Number of study hours	15.0	0.0	15.0	0.0		0.0	30
	E-learning hours included: 0.0							
Learning activity and number of study hours	Learning activity	Participation in classes includ plan	n didactic ed in study	idactic Participation in in consultation hours		Self-study SUI		SUM
	Number of study hours	30		8.0		37.0		75
Subject objectives	Presentation of the vacuum methods of preparation of thin films and plasma surface modification processes and applications of thin films as well as practical acquaintance with thin-film technology in the laboratory processes.							
Learning outcomes	Course outcome		Subject outcome			Method of verification		
	K7_U01		The student has the knowledge of where to find information on the parameters of deposition of thin- film structures and the design of CVD and PVD processes.			[SU4] Assessment of ability to use methods and tools		
	K7_W04		The student is able to correlate the parameters of materials with each other and adjust their structures in order to obtain specific physical and mechanical properties.			[SW1] Assessment of factual knowledge		
	K7_U04		The student is able to design the process of synthesis of thin-film samples and to develop the results of research on such structures.			[SU2] Assessment of ability to analyse information		
	K7_W05		The student knows the CVD and PVD techniques as well as tools and materials for their use.			[SW3] Assessment of knowledge contained in written work and projects		
	K7_K01		The student has knowledge of the direction in which thin film technology and CVD and PVD processes develop.			[SK3] Assessment of ability to organize work		

Subject contents	Methods of producing and measuring vacuum.						
	Overview of the vacuum technology. The growth process of thin films: condensation, nucleation, growth. Monitoring of the layer growth. Basic parameters of thin films and methods of measurement: thickness, adhesion, defects, chemical structure and physical. Types of substrates and methods of their preparation for specific processes. Processes PVD (Physical Vapour Deposition) production of metallic and non-metallic layers. Evaporation conventional and electron beam evaporation, sputtering and reactive sputtering. CVD processes (called Chemical Vapor Deposition): pyrolysis and synthesis processes and plasma processes. Review of applications: anti-corrosion coating, thin film technology in engineering, optical coating, thin film technology in microelectronics and nanolayers. Lab program: Processes of "wet" preparation of substrates and ion cleaning of substrates. Production and measurement of vacuum. Starting the PVD process. Starting the PVD process of the layers by interference spectroscopy. Preparation of the CVD processes of thin film layers on the example of the diamond. Parameterisation of the process of plasma enhanced CVD process.						
Prerequisites							
and co-requisites		T					
Assessment methods and criteria	Subject passing criteria	Passing threshold	Percentage of the final grade				
	lecture test	50.0%	50.0%				
	lab report	50.0%	50.0%				
Recommended reading	Basic literature	A. Hałas, Technologia wysokiej próżni, PWN, Warszawa,1990 K.L Lesker, Vacuum Products,2007.					
		J. R. Roth, Industrial Plasma Engir	eering, IOP, Bristol,1995.				
		R. J. Shul, S.J. Peartson, Handboo Techniques, Springer, Berlin, 2000	ok of Advanced Plasma Processing				
	Supplementary literature	-					
	eResources addresses	Adresy na platformie eNauczanie:					
Example issues/ example questions/ tasks being completed	 Preparation of substrates and undercover equipment for the PVD process. The process of PVD (thermal evaporation) deposition of thin Al layers from a wire evaporator. Masking of structures. The process of PVD (thermal evaporation) deposition of thin Ag and Cu layers on monocrystalline silicon and glass substrates. Layer resistivity measurements. The PVD (flash evaporation + thermal evaporation) deposition process of NiCr / Au thin films. The process of deposition of diamond layers in PA CVD in microwave plasma. Microscopic observations of sample surfaces. 						
Work placement	Not applicable						